



Form PTO-1449 U.S. Dept. of Commerce, Patent and Trademarks

## LIST OF ART CITED BY APPLICANT

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Attorney Docket No.  
CM03351J

Serial No.

09/828,431

Filing Date

4/9/01

Applicant:  
Kenneth D. Cornett

Group

2817

#2

## U.S. PATENT DOCUMENTS

Examiner's Initial		Document No.	Date	Name	Class	Subclass	
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						

## FOREIGN PATENT DOCUMENTS

		Document No.	Date	Country	Class	Subclass	Translation Yes or No
B8	AI	EP 1045 448 A1	10/18/200	EPO			
	AJ						
	AK						

## OTHER PRIOR ART (Including Author Title, Date, Pertinent Pages, etc.)

B8	AL	Wang, Kun et al. VHF Free-Free Beam High Q Micromechanical Resonators. Technical Digest, 12 <sup>th</sup> International IEEE Micro Electro Mechanical System Conference, Orlando, Florida Jan 17-21, 1999, pp 453-458.					
B8	AM	Wang, Kun et al. VHF Free-Free Beam High Q Micromechanical Resonators. Journal of Microelectromechanical Systems, Vol 9, No. 3 (September 2000), pp 347-359.					
B8	AN	Ayazi, Farrokh et al. High Aspect-Ratio Combined Poly and Single-Crystal Silicon (HARPSS) MEMSS Technology. Journal of Microelectromechanical Systems, Vol, 9, No. 3 (September 2000), pp 288-294.					

EXAMINER

Barbara Summons

DATE CONSIDERED:

5/8/03

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BB	AL	Web page entitled "New Developments in Canon ELTRAN SOI Wafer Technology, <a href="http://www.usa.canon.com/indtech/semicondeq/news_developments.html">http://www.usa.canon.com/indtech/semicondeq/news_developments.html</a> , printed 3/21/01 (6 pages).
BB	AM	Flandre, Denis, Colinge, Jean Pierre, Status and Trends of SOI, <a href="http://www.dice.ucl.ac.be/%7EFlandre/ESSCIRC94/ESSCIRC94.html">http://www.dice.ucl.ac.be/%7EFlandre/ESSCIRC94/ESSCIRC94.html</a> , printed 3/21/01 (11 pages).
BB	AN	Goselle, U., Tong, Q.Y., Science and Technology of Semiconductor Wafer Bonding (Tentative), Chapter 7, <a href="http://www.duke.edu/web/wbl/ch7/ch7-hpge.html">http://www.duke.edu/web/wbl/ch7/ch7-hpge.html</a> , printed 3/20/01 (28 pages) [Table of Contents, 11 pages].

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Paula Summora

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